

# N-Channel Super Junction Power MOSFET $\,\,{\rm IV}$

#### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

#### Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

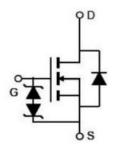
#### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

#### Package Marking And Ordering Information

Device	Device Package	Marking
NCE65N290F	TO-220F	NCE65N290F

# V<sub>DS min@Tjmax</sub> 710 V R<sub>DS(ON)TYP</sub>. 260 mΩ I<sub>D</sub> 13 A Qg 15 nC



#### Schematic diagram



TO-220F

#### Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGs=0V)	Vds	650	V
Gate-Source Voltage (V <sub>DS=0</sub> V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	13	A
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	9.1	A
Pulsed drain current <sup>(Note 1)</sup>	I <sub>DM (pluse)</sub>	39	A
Maximum Power Dissipation(Tc=25°C)	PD	32.9	W
Derate above 25°C		0.22	W/°C
Single pulse avalanche current (Note 2)	I <sub>AS</sub>	3	A
Reverse diode dv/dt, $V_{DS} \leqslant 480 V, I_{SD} < I_D$	dv/dt	15	V/ns
Drain Source voltage slope, $V_{DS} \leqslant 480 V$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55+175	°C



#### Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	4.56	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	62	°C /W

#### Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250uA	650			V
Zero Gate Voltage Drain Current(Tc=25°C)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°C)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			50	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm 20V, V_{DS}=0V$			±200	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	3		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A		260	290	mΩ
Dynamic Characteristics					·	
Gate Resistance	Rg	F=1MHZ, D-S short		16		Ω
Input Capacitance	Clss	- V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, F=1MHz		847		pF
Output Capacitance	Coss			37		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			5		pF
Total Gate Charge	Qg			15	18	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =450V,I <sub>D</sub> =6.5A,		2		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V		5		nC
Gate plateau voltage	Vgp			5.3		V
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =380V,I <sub>D</sub> =6.5A, R <sub>G</sub> =4Ω,V <sub>GS</sub> =10V		10		nS
Turn-on Rise Time	tr			9		nS
Turn-Off Delay Time	t <sub>d(off)</sub>			55		nS
Turn-Off Fall Time	t <sub>f</sub>			9		nS
Source- Drain Diode Characteristics			•			
Source-drain current(Body Diode)	I <sub>SD</sub>	T -05%0			13	А
Pulsed-Source-drain current(Body Diode)	I <sub>SDM</sub>	T <sub>c</sub> =25°C			39	А
Forward on voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =13A,V <sub>GS</sub> =0V		0.9	1.1	V
Reverse Recovery Time	t <sub>rr</sub>	Tj=25°C,I <sub>F=</sub> 6.5A,		230		nS
Reverse Recovery Charge	Qrr			1.84		uC
Peak reverse recovery current	Irrm	di/dt=100A/µs		16		А

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25  $^\circ\!\mathrm{C}$  ,VDD=50V,VG=10V, R\_G=25 $\Omega$ 



### **TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)**

#### Figure1. Safe operating area



Figure3. Transfer characteristics

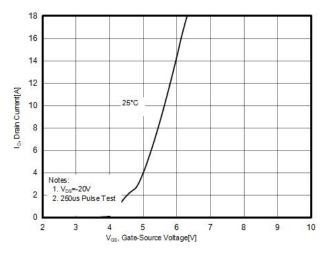


Figure5. Static drain-source on resistance

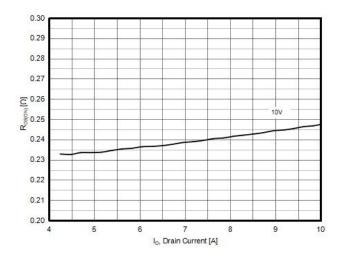


Figure2. Source-Drain Diode Forward Voltage

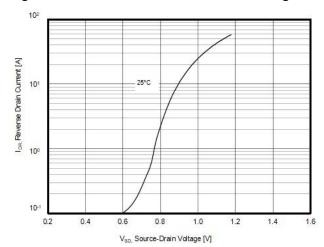


Figure4. Output characteristics

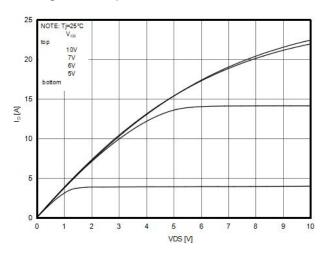


Figure6. RDS(ON) vs Junction Temperature

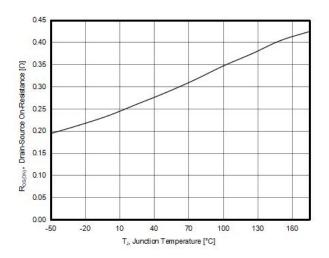




Figure7. BV<sub>DSS</sub> vs Junction Temperature

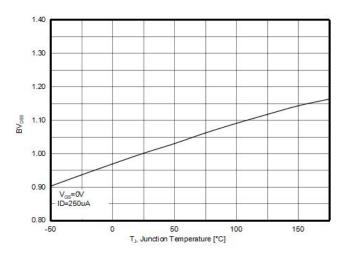


Figure8. Maximum I<sub>D</sub> vs Junction Temperature

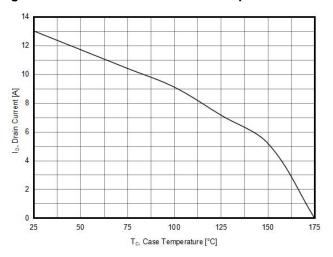


Figure9. Gate charge waveforms

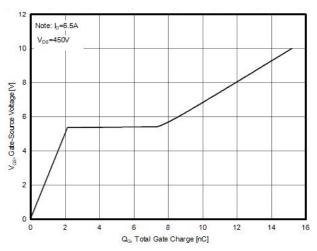
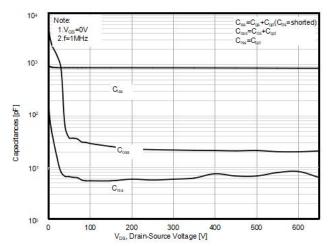


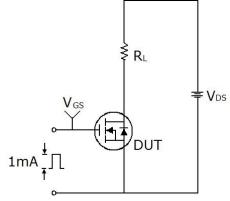
Figure10. Capacitance

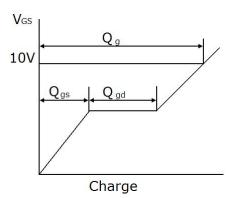




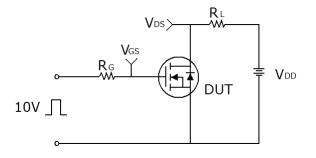
## **Test circuit**

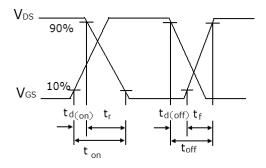
1) Gate charge test circuit & Waveform



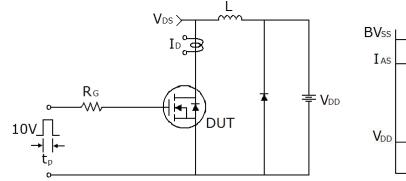


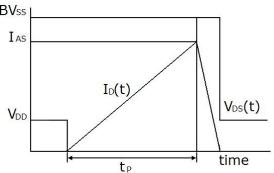
2) Switch Time Test Circuit:





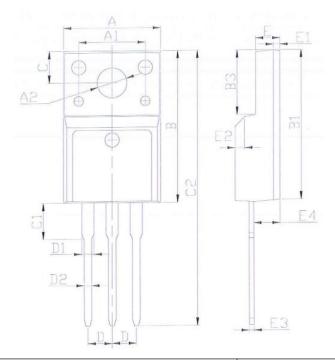
#### 3) Unclamped Inductive Switching Test Circuit & Waveforms







# **TO-220F-L Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	9.86	10.46	0.387	0.411	
A1	6.80	7.20	0.267	0.283	
A2	2.92	3.32	0.115	0.130	
A3	9.40	10.00	0.369	0.393	
В	15.40	16.40	0.605	0.644	
B1	15.10	16.10	0.593	0.633	
B2	4.40	5.00	0.173	0.196	
B3	6.40	7.00	0.251	0.275	
С	3.05	3.55	0.120	0.139	
C1	2.95	3.55	0.116	0.139	
C2	28.20	29.20	1.108	1.147	
D	2.54 BSC		0.100 BSC		
D1		1.47		0.058	
D2	0.60	1.00	0.024	0.039	
E	2.30	2.80	0.090	0.110	
E1	0.45	0.95	0.018	0.037	
E2	45.0°		45.00°		
E3	0.30	0.70	0.012	0.028	
E4	2.45	3.05	0.096	0.120	



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